

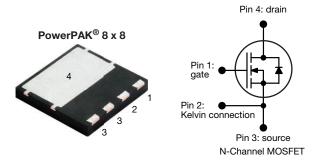
COMPLIANT

HALOGEN

FREE GREEN



E Series Power MOSFET



| PRODUCT SUMMARY | | | | | |
|--|-------------------------|--------|--|--|--|
| V _{DS} (V) at T _J max. | ax. 650 | | | | |
| R _{DS(on)} typ. (Ω) at 25 °C | $V_{GS} = 10 \text{ V}$ | 0.137 | | | |
| Q _g max. (nC) | 3 | 6 | | | |
| Q _{gs} (nC) | 1 | 0 | | | |
| Q _{gd} (nC) | 6 | | | | |
| Configuration | Sin | Single | | | |

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) R_{on} x Q_g
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

| ORDERING INFORMATION | |
|---------------------------------|--------------------|
| Package | PowerPAK® 8 x 8 |
| Lead (Pb)-free and halogen-free | SiHH150N60E-T1-GE3 |

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | |
|--|--|-------------------------|-----------------------------------|-------------|------|
| PARAMETER | | | SYMBOL | LIMIT | UNIT |
| Drain-source voltage | | | V_{DS} | 600 | V |
| Gate-source voltage | | | V_{GS} | ± 30 | V |
| Continuous drain surrent (T. 150 °C) | Continuous drain current $(T_1 - 150 ^{\circ}\text{C})$ V_{CC} at 10 V_{CC} | | | 19 | |
| Continuous drain current (T _J = 150 °C) | V _{GS} at 10 V | T _C = 100 °C | Ι _D | 12 | Α |
| Pulsed drain current ^a | | | I _{DM} | 43 | 1 |
| Linear derating factor | | | | 1.04 | W/°C |
| Single pulse avalanche energy b | | | E _{AS} | 179 | mJ |
| Maximum power dissipation | | | P _D | 156 | W |
| Operating junction and storage temperature range | | | T _J , T _{stg} | -55 to +150 | °C |
| Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$ | | | dv/dt | 100 | V/ns |
| Reverse diode dv/dt d | | | | 5 | v/ns |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.8 A
- c. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting $T_J = 25$ °C



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| THERMAL RESISTANCE RATINGS | | | | | | | |
|----------------------------------|------------|------|------|------|--|--|--|
| PARAMETER SYMBOL TYP. MAX. UNIT | | | | | | | |
| Maximum junction-to-ambient | R_{thJA} | 42 | 55 | °C/W | | | |
| Maximum junction-to-case (drain) | R_{thJC} | 0.72 | 0.96 | C/VV | | | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|---|---|------|-------|-------|------|
| Static | | - | | | • | | |
| Drain-source breakdown voltage | V _{DS} | V _{GS} = | = 0 V, I _D = 250 μA | 600 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, I _D = 1 mA | - | 0.62 | - | V/°C |
| Gate-source threshold voltage (N) | V _{GS(th)} | V _{DS} = | · V _{GS} , I _D = 250 μA | 3.0 | - | 5.0 | V |
| Cata aguirra laglaga | | , | V _{GS} = ± 20 V | | - | ± 100 | nA |
| Gate-source leakage | I_{GSS} | , | $V_{GS} = \pm 30 \text{ V}$ | - | - | ± 1 | μΑ |
| Zava gata valtaga dyain avyyant | | V _{DS} = | $V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ | | - | 1 | |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 480 V | ', V _{GS} = 0 V, T _J = 125 °C | - | - | 10 | μA |
| Drain-source on-state resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 10 A | - | 0.137 | 0.158 | Ω |
| Forward transconductance a | 9 _{fs} | V _{DS} | = 10 V, I _D = 10 A | - | 5.1 | - | S |
| Dynamic | | | | | | | |
| Input capacitance | C _{iss} | | $V_{GS} = 0 V$, | - | 1514 | - | |
| Output capacitance | C _{oss} | | V _{DS} = 100 V, | - | 60 | - | 1 |
| Reverse transfer capacitance | C _{rss} | | f = 100 KHz | | 2 | - | pF |
| Effective output capacitance, energy related | C _{o(er)} | $V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$ | | - | 58 | - | |
| Effective output capacitance, time related | C _{o(tr)} | | | - | 322 | - | |
| Total gate charge | Qg | | | - | 24 | 36 | |
| Gate-source charge | Q _{gs} | $V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 480 \text{ V}$ | | - | 10 | - | nC |
| Gate-drain charge | Q _{gd} | | | - | 6 | - | |
| Turn-on delay time | t _{d(on)} | | | - | 20 | 40 | |
| Rise time | t _r | $V_{DD} = 480 \text{ V}, I_D = 10 \text{ A},$ | | - | 27 | 54 | ne |
| Turn-off delay time | t _{d(off)} | V _{GS} = | = 10 V, R_g = 9.1 Ω | - | 28 | 56 | ns |
| Fall time | t _f | | | - | 17 | 34 | |
| Gate input resistance | R_g | f = 1 MHz, open drain | | 0.4 | 0.9 | 1.8 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous source-drain diode current | Is | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 22 | |
| Pulsed diode forward current | I _{SM} | | | - | - | 43 | - A |
| Diode forward voltage | V _{SD} | T _J = 25 °C, I _S = 10 A, V _{GS} = 0 V | | - | - | 1.2 | V |
| Reverse recovery time | t _{rr} | 0 == 0,10 ===1,100 0 | | - | 291 | 582 | ns |
| Reverse recovery charge | Q _{rr} | $T_J = 25 \text{ °C}, I_F = I_S = 10 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$ | | - | 3.5 | 7.0 | μC |
| Reverse recovery current | I _{RRM} | | | _ | 21 | - | A |



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

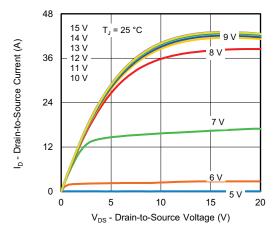


Fig. 1 - Typical Output Characteristics

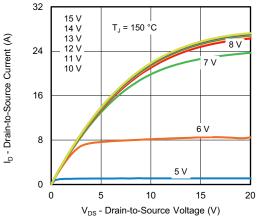


Fig. 2 - Typical Output Characteristics

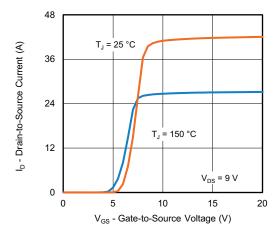


Fig. 3 - Typical Transfer Characteristics

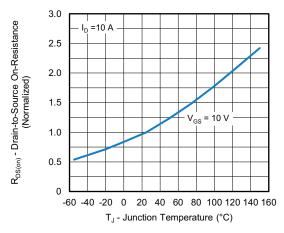


Fig. 4 - Normalized On-Resistance vs. Temperature

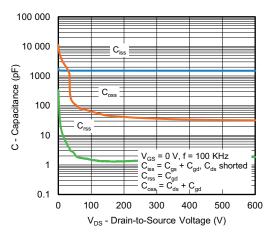


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

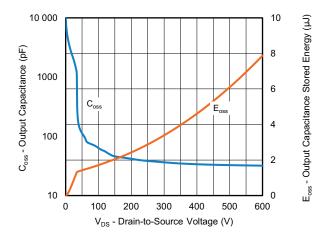


Fig. 6 - Coss and Eoss vs. VDS



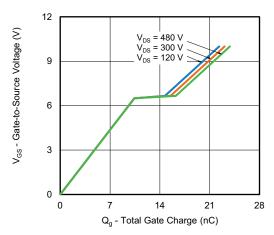


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

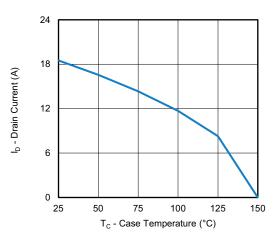


Fig. 9 - Maximum Drain Current vs. Case Temperature

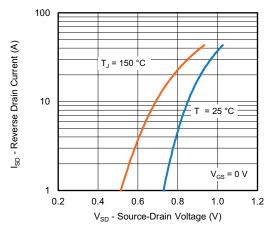


Fig. 8 - Typical Source-Drain Diode Forward Voltage

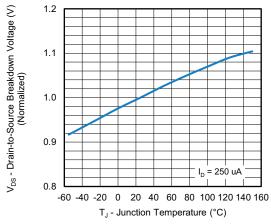


Fig. 10 - Temperature vs. Drain-to-Source Voltage

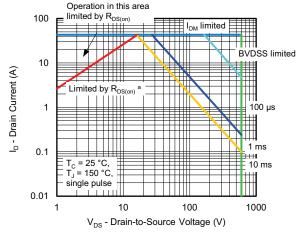


Fig. 11 - Maximum Safe Operating Area

Note

d. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified



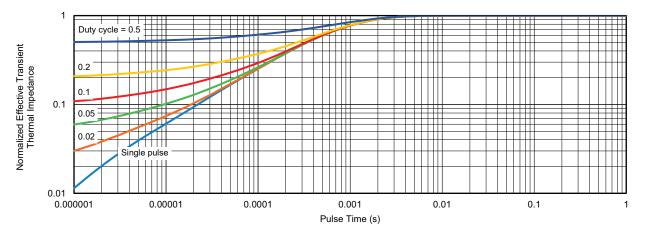


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

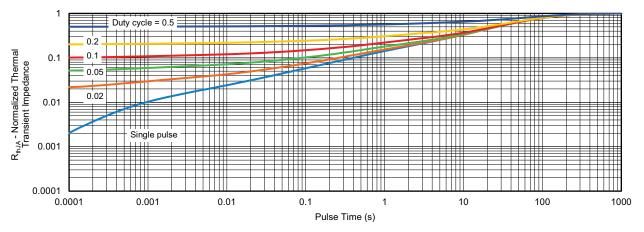


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

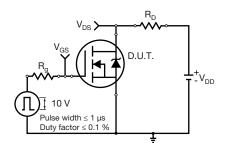


Fig. 14 - Switching Time Test Circuit

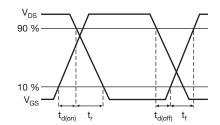


Fig. 15 - Switching Time Waveforms



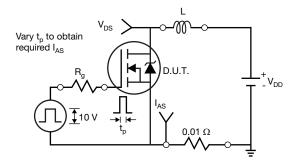


Fig. 16 - Unclamped Inductive Test Circuit

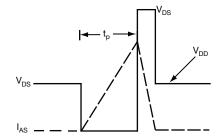


Fig. 17 - Unclamped Inductive Waveforms

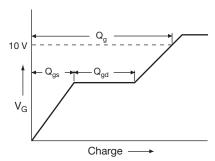


Fig. 18 - Basic Gate Charge Waveform

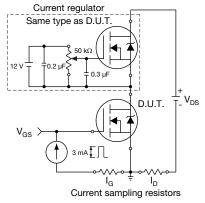
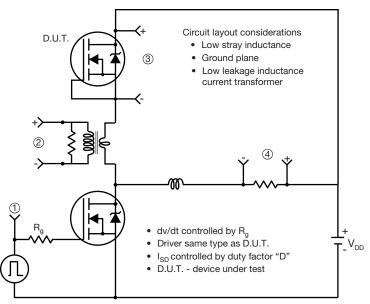


Fig. 19 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



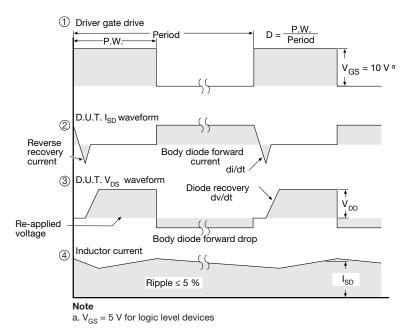


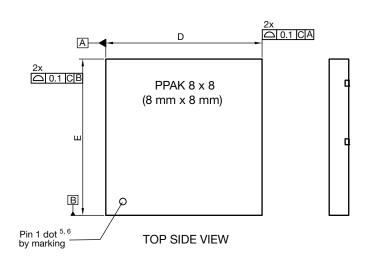
Fig. 20 - For N-Channel

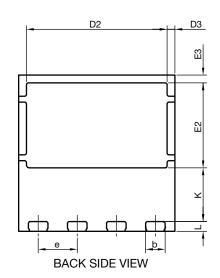
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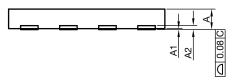


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PowerPAK® 8 x 8 Case Outline







| DIM | MILLIMETERS | | | INCHES | | | | |
|------------------|-------------|----------|-----------|------------|--------------------|-------|--|--|
| DIM. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | | |
| А | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 | | |
| A1 | 0.00 | - | 0.05 | 0.000 | - | 0.002 | | |
| A2 | | 020 ref. | | 0.008 ref. | | | | |
| b | 0.95 | 1.00 | 1.05 | 0.037 | 0.039 | 0.041 | | |
| D | 7.90 | 8.00 | 8.10 | 0.311 | 0.315 | 0.319 | | |
| D2 | 7.10 | 7.20 | 7.30 | 0.280 | 0.283 | 0.287 | | |
| D3 | 0.40 BSC | | | 0.016 BSC | | | | |
| е | | 2.00 BSC | | 0.079 BSC | | | | |
| Е | 7.90 | 8.00 | 8.10 | 0.311 | 0.315 | 0.319 | | |
| E2 | 4.30 | 4.35 | 4.40 | 0.169 | 0.171 | 0.173 | | |
| E3 | | 0.40 BSC | | | 0.40 BSC 0.016 BSC | | | |
| K | 2.75 BSC | | 0.108 BSC | | | | | |
| L | 0.45 | 0.50 | 0.55 | 0.018 | 0.020 | 0.022 | | |
| N ⁽³⁾ | 8 | | | | 8 | | | |

Notes

- (1) Use millimeters as the primary measurement
- (2) Dimensioning and tolerances conform to ASME Y14.5 M 1994
- (3) N is the number of terminals
- (4) The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body
- (5) Exact shape and size of this feature is optional

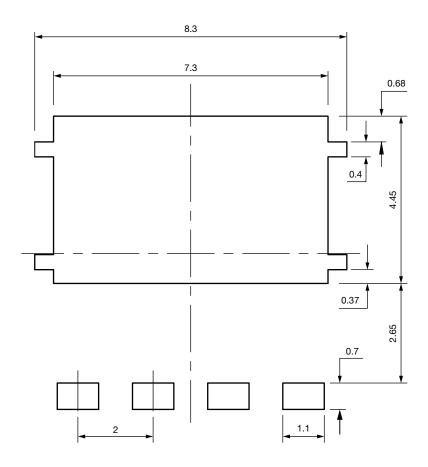
ECN: E20-0518-Rev. B, 28-Sep-2020

DWG: 6041

Revision: 28-Sep-2020 1 Document Number: 67859



Recommended Minimum PADs for PowerPAK® 8 mm x 8 mm



Dimensions in millimeters



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